





60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D T _A = 25°C
601/	68m $Ω$ @ V _{GS} = 10 V	8.5A
60V	100mΩ @ V _{GS} = 4.5V	7.0A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- · Transformer Driving Switch
- DC-DC Converters
- Power Management Functions
- Uninterrupted Power Supply

Features and Benefits

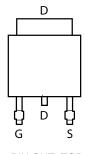
- 100% Unclamped Inductive Switch (UIS) test in production
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

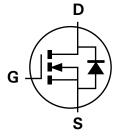
- Case: TO252-3L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208
- · Weight: 0.33 grams (approximate)



TOP VIEW



PIN OUT -TOP



Equivalent Circuit

Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMN6068LK3-13	N6068L	13	16	2,500	

Note: 1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

Marking Information



O!! = Manufacturer's Marking
N6068L = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 09 = 2009)
WW = Week (01-52)





Maximum Ratings @T_A = 25°C unless otherwise specified

Cha	aracteristic		Symbol Value		Unit	
Drain-Source voltage			V_{DSS}	60	V	
Gate-Source voltage (Note 2)			V_{GS}	±20	V	
Single Pulsed Avalanche Energy (Note 8)			E _{AS}	37.5	mJ	
Single Pulsed Avalanche Cu	(Note 8)	I _{AS}	5.0	Α		
		(Note 4)	I _D	8.5		
Continuous Drain current	$V_{GS} = 10V$	$T_A = 70^{\circ}C \text{ (Note 4)}$		6.8	Α	
		(Note 3)		6.0		
Pulsed Drain current V _{GS} = 10V		(Note 5)	I _{DM}	22.2	Α	
Continuous Source current (Body diode) (Note 4)		(Note 4)	I _S	10.2	Α	
Pulsed Source current (Body diode) (Note 5)		(Note 5)	I _{SM}	22.2	Α	

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
	(Note 3)		4.12 33		
Power dissipation Linear derating factor	(Note 4)	P _D	8.49 67.9	W mW/°C	
	(Note 6)		2.12 16.9		
	(Note 3)	R _B JA 14.7			
Thermal Resistance, Junction to Ambient	(Note 4)			20.004	
	(Note 6)		59.0	°C/W	
Thermal Resistance, Junction to Lead	(Note 7)	$R_{ heta JL}$	3.09		
Operating and storage temperature range		T _J , T _{STG}	-55 to 150	°C	

Notes:

- 2. AEC-Q101 V_{GS} maximum is $\pm 16V$.
- 3. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

- ## Reasured when operating in a steady-state condition.

 4. Same as note 2, except the device is measured at t ≤ 10 sec.

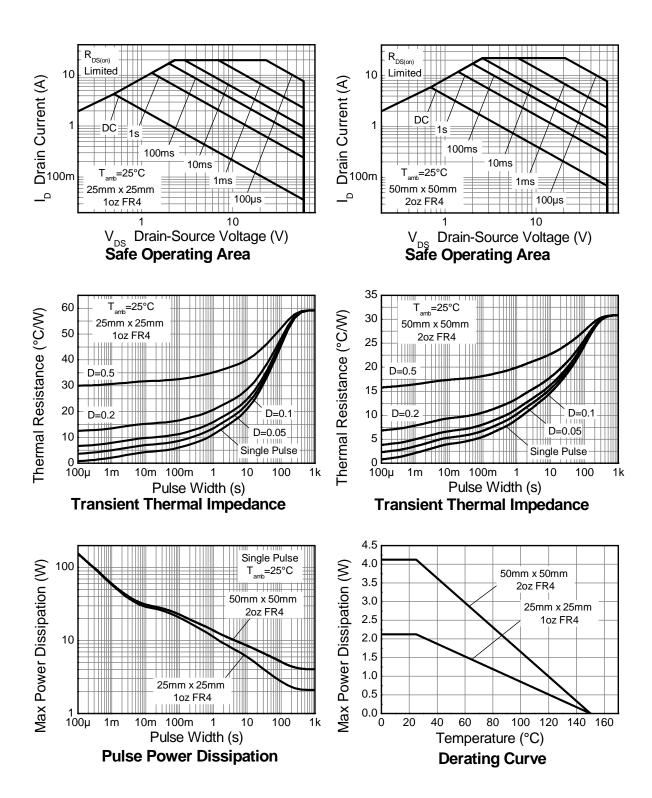
 5. Same as note 2, except the device is pulsed with D = 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.

 6. For a device surface mounted on 25mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

 7. The real resistance from irregion to solder point (at the end of the drain lead).
- 7. Thermal resistance from junction to solder-point (at the end of the drain lead).
- 8. UIS in production with L = 3.0mH, I_{AS} = 5.0Å, R_{G} = 25 Ω , V_{DD} = 50V, starting T_{J} = 25 $^{\circ}$ C



Thermal Characteristics







Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test C	ondition		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$			
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μА	V _{DS} = 60V, V _{GS} =	0V		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS}	= 0V		
ON CHARACTERISTICS	ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(th)}	1.0		3.0	V	I _D = 250μA, V _{DS} =	= V _{GS}		
Static Drain-Source On-Resistance (Note 9)	Dec (cu)			0.068	Ω	V _{GS} = 10V, I _D = 1	2A		
Static Dialif-Source Off-Resistance (Note 9)	R _{DS} (ON)	_		0.100	22	$V_{GS} = 4.5V, I_{D} = 6$	SA .		
Forward Transconductance (Notes 9 & 10)	g _{fs}	_	19.7	_	S	V _{DS} = 15V, I _D = 1	2A		
Diode Forward Voltage (Note 9)	V_{SD}	_	0.98	1.15	٧	I _S = 12A, V _{GS} = 0V			
Reverse recovery time (Note 10)	t _{rr}		145	_	ns	1 404 4:/44 4004/ -			
Reverse recovery charge (Note 10)	Q _{rr}	_	929	_	nC	I _S = 12A, di/dt= 100A/μs			
DYNAMIC CHARACTERISTICS (Note 10)									
Input Capacitance	C _{iss}	_	502	_	pF	.,			
Output Capacitance	Coss	_	45.7	_	pF	V _{DS} = 30V, V _{GS} = 0V -f= 1MHz			
Reverse Transfer Capacitance	C _{rss}	_	27.1	_	pF	1= 1101112	_		
Total Gate Charge	Qg	_	5.55	_	nC	V _{GS} = 4.5V			
Total Gate Charge	Qg	_	10.3	_	nC		V _{DS} = 30V		
Gate-Source Charge	Q_{gs}	_	1.6	_	nC	V _{GS} = 10V I _D = 12A			
Gate-Drain Charge	Q_{gd}	_	3.5	_	nC				
Turn-On Delay Time (Note 11)	t _{D(on)}	_	3.6	_	ns				
Turn-On Rise Time (Note 11)	t _r	_	10.8		ns	V _{DD} = 30V, V _{GS} = 10V			
Turn-Off Delay Time (Note 11)	t _{D(off)}	_	11.9		ns	$I_D=12A, R_G \cong 6.0\Omega$			
Turn-Off Fall Time (Note 11)	t _f	_	8.7	_	ns	<u> </u>			

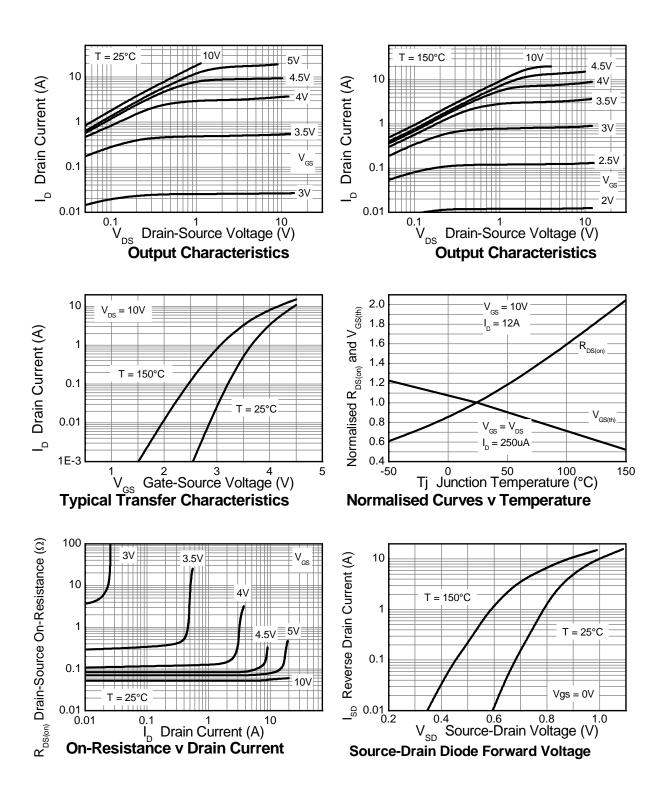
Notes:

- 9. Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$ 10. For design aid only, not subject to production testing.
- 11. Switching characteristics are independent of operating junction temperatures.





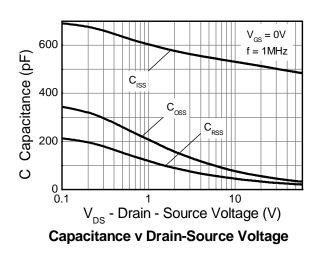
Typical Characteristics

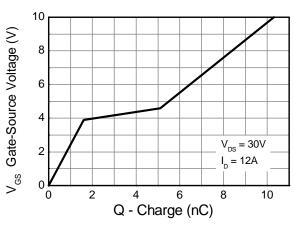




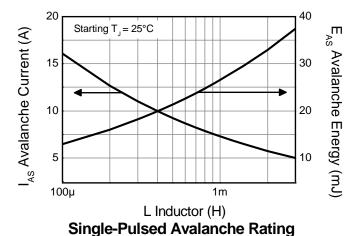


Typical Characteristics - continued





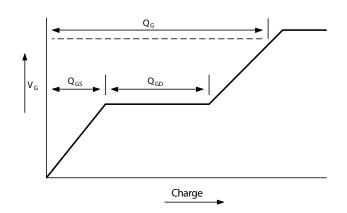
Gate-Source Voltage v Gate Charge

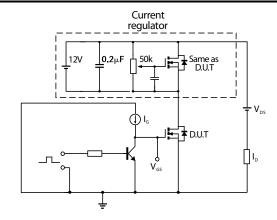






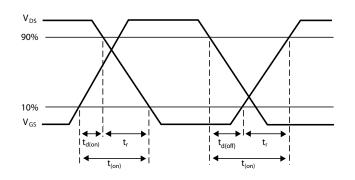
Test Circuits

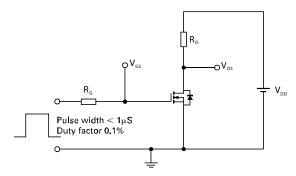




Basic gate charge waveform

Gate charge test circuit



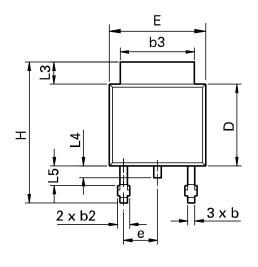


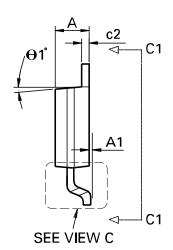
Switching time waveforms

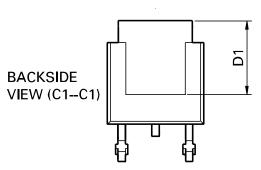
Switching time test circuit

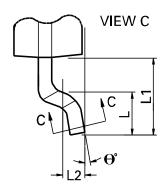


Package Outline Dimensions





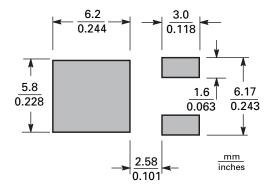




DIM	/ Inches		Millimeters		DIM	Inches		Millimeters			
	Min	Max	Min	Max		Min	Max	Min	Max		
Α	0.086	0.094	2.18	2.39	е	0.090	BSC	2.29 BSC			
A1	-	0.005	-	0.127	Н	0.370	0.410	9.40	10.41		
b	0.020	0.035	0.508	0.89	L	0.055	0.070	1.40	1.78		
b2	0.030	0.045	0.762	1.14	L1	0.108 REF		L1 0.108 REF		2.74	REF
b3	0.205	0.215	5.21	5.46	L2	0.020	0.020 BSC		0.508 BSC		
С	0.018	0.024	0.457	0.61	L3	0.035	0.065	0.89	1.65		
c2	0.018	0.023	0.457	0.584	L4	0.025	0.040	0.635	1.016		
D	0.213	0.245	5.41	6.22	L5	0.045	0.060	1.14	1.52		
D1	0.205	-	5.21	-	θ1°	0°	10°	0°	10°		
E	0.250	0.265	6.35	6.73	θ°	0°	15°	0°	15°		
E1	0.170	-	4.32	-	-	-	-	-	_		



Suggested Pad Layout



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